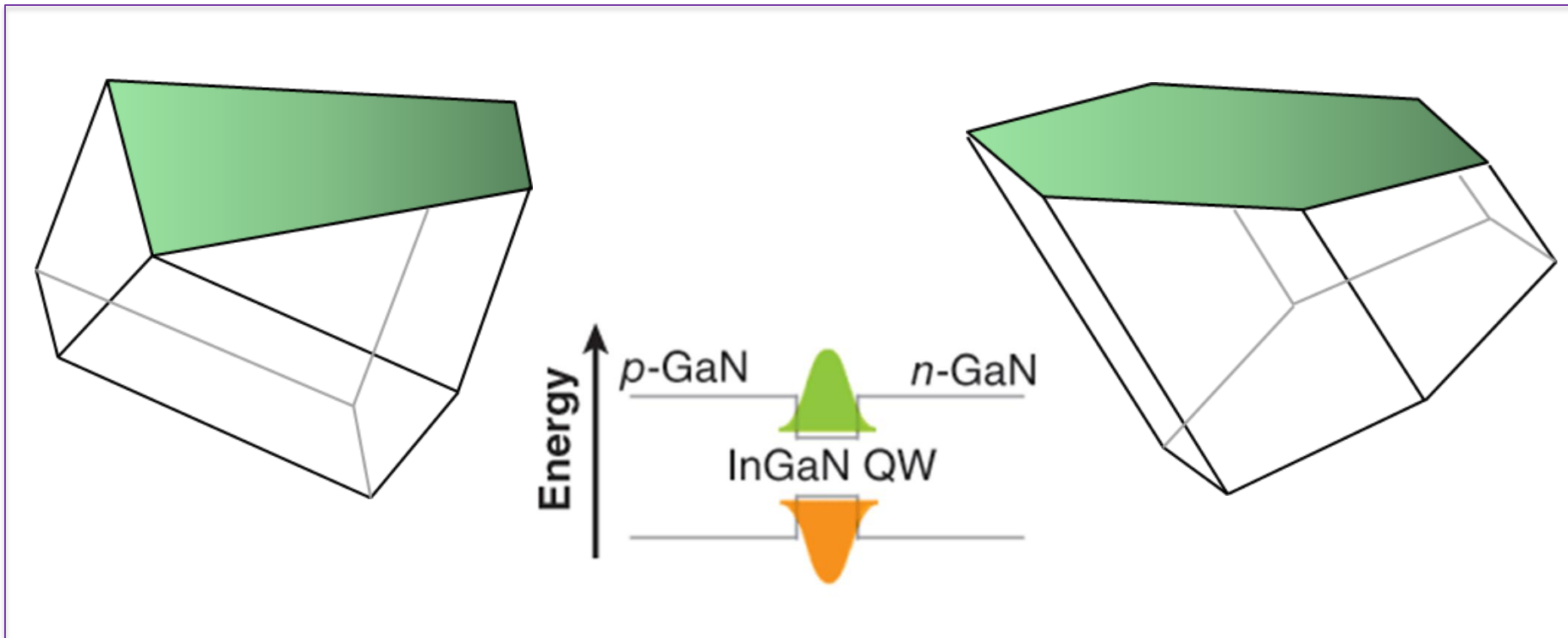


# LEDs on Semipolar Bulk GaN Substrate with IQE > 80% at 150 A/cm<sup>2</sup> and 100 °C

2014 Building Technologies Office Peer Review



# Project Summary

## Timeline:

Start date: **9/1/2011**

Planned end date: **8/31/2014**

## Key Milestones

1. Yr 1: IQE >70% at 405 nm at 150 A/cm<sup>2</sup> and 100 °C
2. Yr 2: IQE >80% at 405 - 450 nm at 150 A/cm<sup>2</sup> and 100 °C

## Budget:

Total DOE \$ to date: **\$462,167.33**

Total future DOE \$: **\$217,696.42**

## Target Market/Audience:

Solid State Lighting

Key Partners: None

## Project Goal:

Demonstrate Light Emitting Diodes on Semipolar Bulk GaN Substrates

1. With Internal Quantum Efficiency (IQE) > 80%
2. At a Current Density (J) of 150 A/cm<sup>2</sup>; and
3. At a Junction Temperature (T<sub>j</sub>) of 100°C

# Purpose and Objectives

**Problem Statement:** This project aims to address the issue related to steep reduction of optical efficiency of GaN based LEDs under high current density operation, commonly known as 'Current Droop'.

**Target Market and Audience:** The target market is Solid State Lighting (SSL).

- In the US, Lighting consumes 18% of the total site electricity use in 2010.
- SSL technology offers a potential saving of 217 TWh, or about one-third of lighting site electricity consumption, by 2025. (Source: DOE SSL MYPP, Pg. 1)

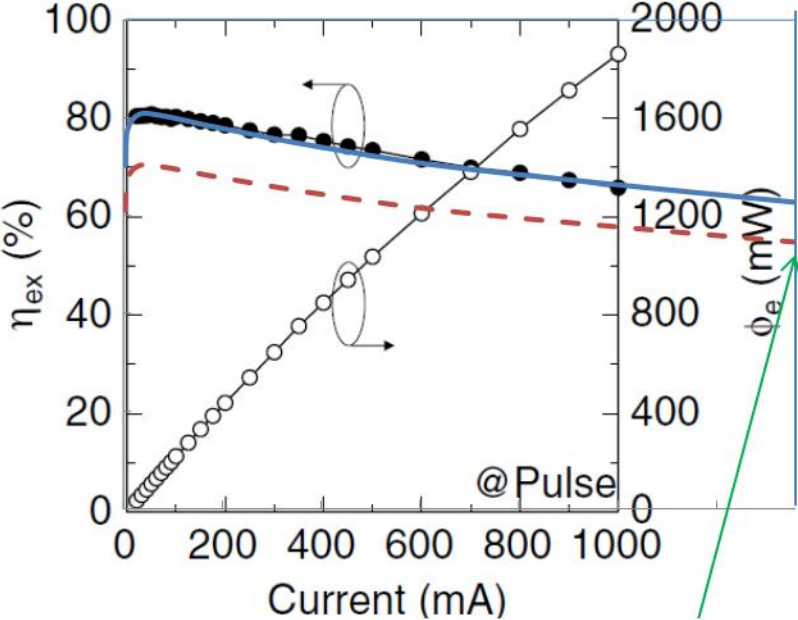
**Impact of Project:** Despite 20+ years of R&D, IQE of state-of-art LEDs is less than 65% under preferred operating condition set by DOE

1. This project aims to achieve IQE > 80% under conditions specified in DOE MYPP
2. Impact path:
  - a. Near-term: Establish proof-of-concept semipolar LED with IQE >80%
  - b. Intermediate-term: Establish product quality semipolar LED with IQE >80%
  - c. Long-term (3yr.+ after project): Manufacture semipolar LED with IQE >80%

# Comparison with State-of-Art

## Best Reported Nichia Data

- Narukawa et al., J. Phys D: Appl. Phys. 43 (2010) 354002



**EQE = 60% (150 A/cm<sup>2</sup>, 100 °C)**

- Extrn. Efficiency assumed: 90% (fits well with IQE model)
- Used best hot/cold: Rebel ES (radiometric Nichia data not available)
- Hot/Cold = 92% at 100C

⇒ **IQE = 65% (150 A/cm<sup>2</sup>, 100 °C)**

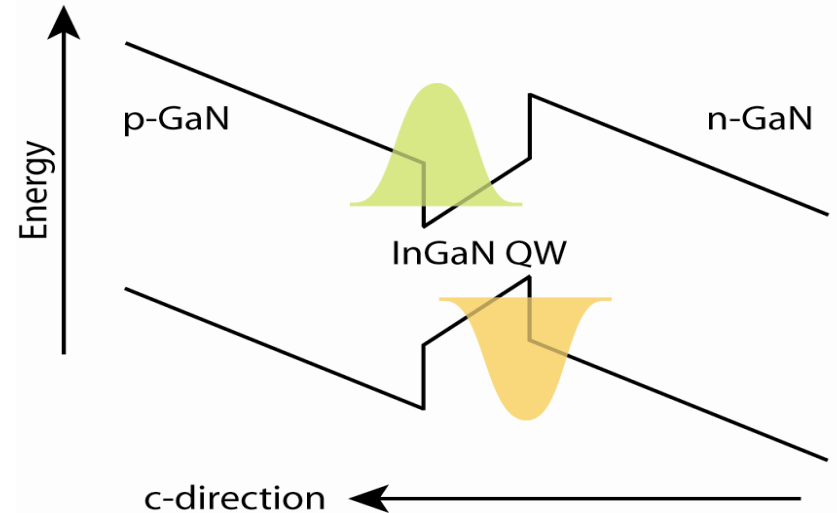
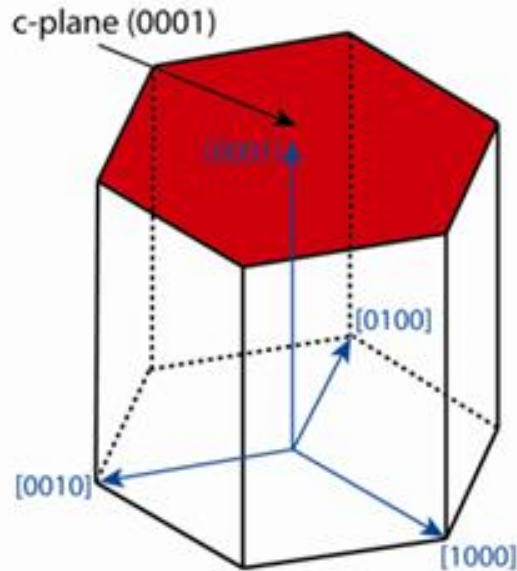
## This Project

Metric	This Program (2013)	2020 MYPP
IQE (@35A/cm <sup>2</sup> )	90%	90%
RT QE Droop (Relative EQE at 150A/cm <sup>2</sup> vs 35A/cm <sup>2</sup> )	95%	90%
RT QE Droop (Relative EQE at 300A/cm <sup>2</sup> vs 35A/cm <sup>2</sup> )	90%	
Thermal Droop (Relative flux at 100C T <sub>j</sub> vs 25C T <sub>j</sub> )	95%	95%
HT QE Droop (Relative EQE at 150A/cm <sup>2</sup> at 100C T <sub>j</sub> vs 35A/cm <sup>2</sup> at 25C)	90%	86%
IQE (@150A/cm <sup>2</sup> @100C T <sub>j</sub> )	81%	77%

**The end of program milestones exceed the state-of-art performance level by >20% (20% increased energy saving)**

# Key Issue: Influence of Polarization induced Electric Field

## Competition: Polar GaN Technology

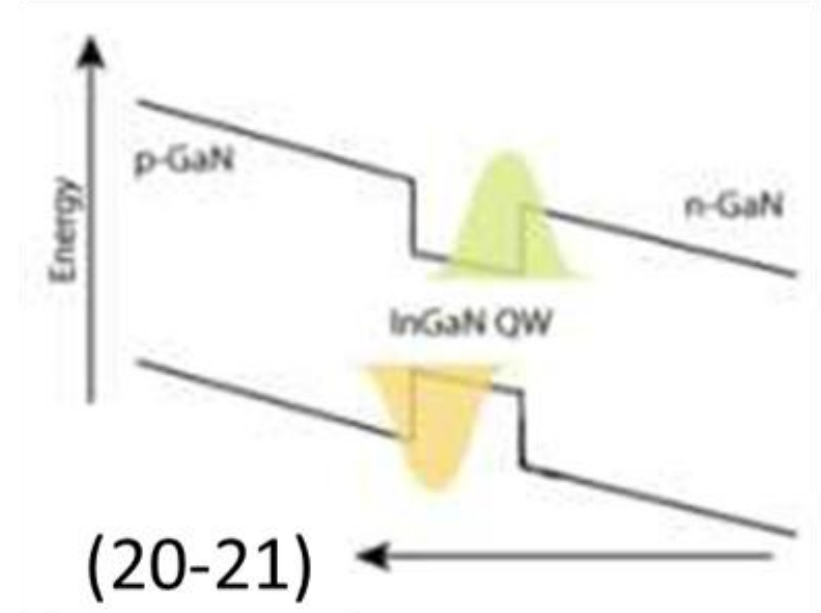
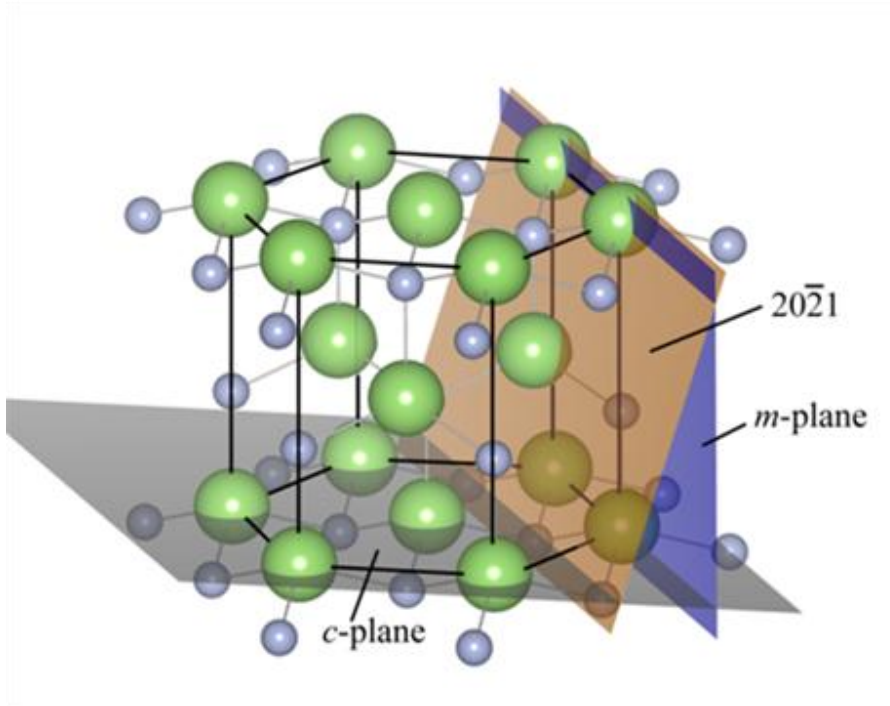


Reduced overlap of electron and hole wave-functions

- > Quantum Confined Stark Effect (QCSE)
- > Reduces oscillator strength and recombination rate

# Distinctive Approach: Use of Nonpolar and Semipolar GaN

## Nonpolar/Semipolar GaN Technology



Increased overlap of electron and hole wave-functions

- > Increases oscillator strength
- > Increases radiative recombination rate

# Approach

$$IQE = \frac{BN^2}{AN + BN^2 + CN^3}$$

Non-radiative Recombination Coefficient  
*(defect/trap related - minimized through use of low defect density bulk GaN substrates)*

Radiative Recombination Coefficient  
*(expected to be higher for nonpolar and semipolar planes)*

Auger Non-radiative Recombination Coefficient  
*(strong dependence on carrier density – nonpolar devices offer significant potential for low carrier density device designs)*

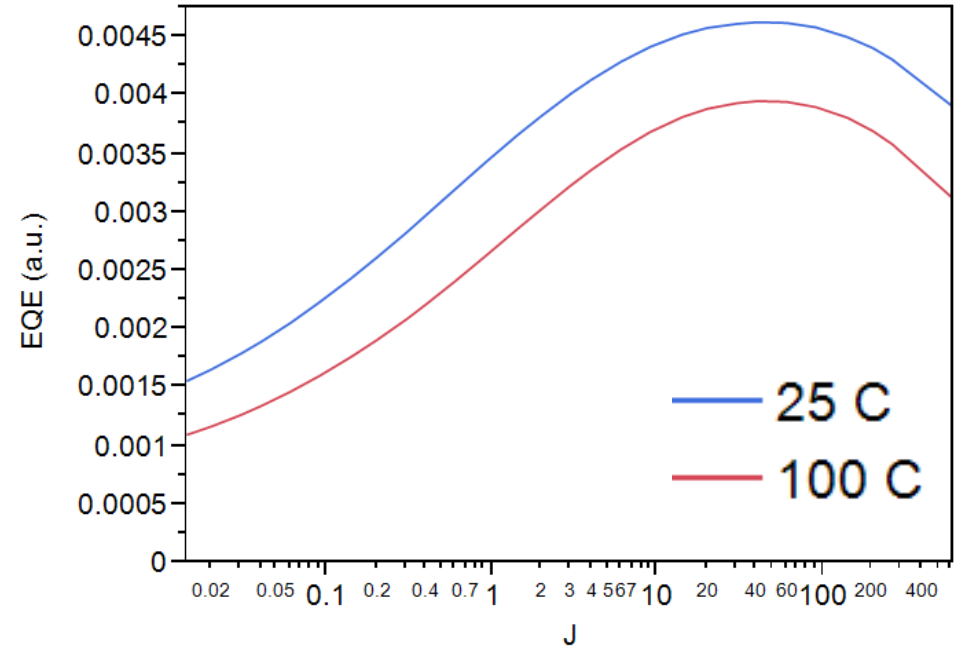
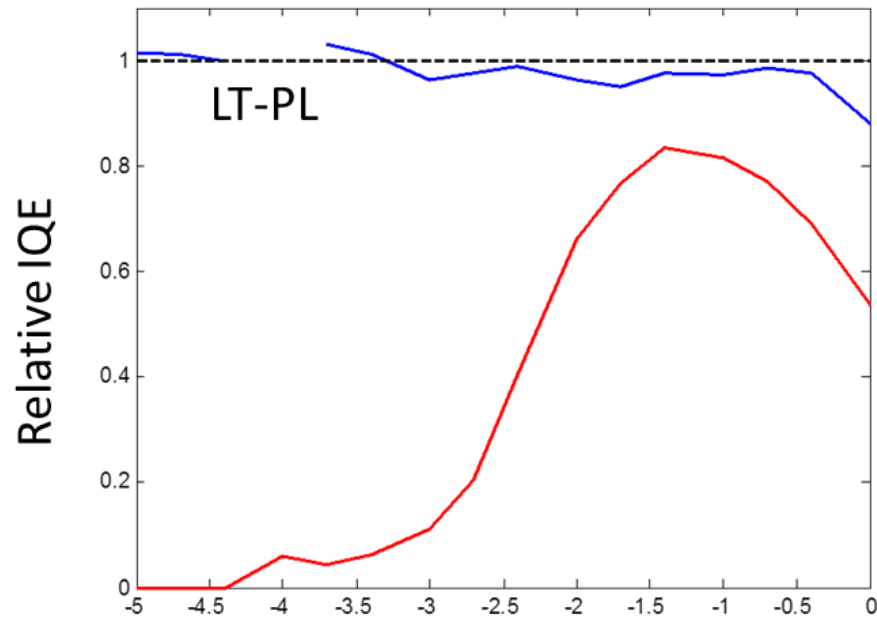
Soraa’s approach for this program employs:

- 1. Bulk GaN substrates: Reduced defect related non-radiative recombination processes (reduced *A* coefficient) compared to heteroepitaxy
- 2. Semipolar orientation: Increased radiative recombination rates (higher *B* coefficient) due to improved electron-hole wavefunction overlap
- 3. Wider design space: Soraa’s novel device design would enable lower carrier density (*N*) in the active region, resulting in reduced Auger recombination

**Soraa’s approach offers key advantages to address IQE roll-over**

# Progress and Accomplishments (End of Year 1)

## Measurement of Internal Quantum Efficiency (IQE)



Peak IQE (measured using Low Temp Photoluminescence) = **85%** (407 nm)

Current droop (measured using Electroluminescence) = **97%**

Thermal droop (measured using High Temp Electroluminescence) = **85%** (to 100 °C)

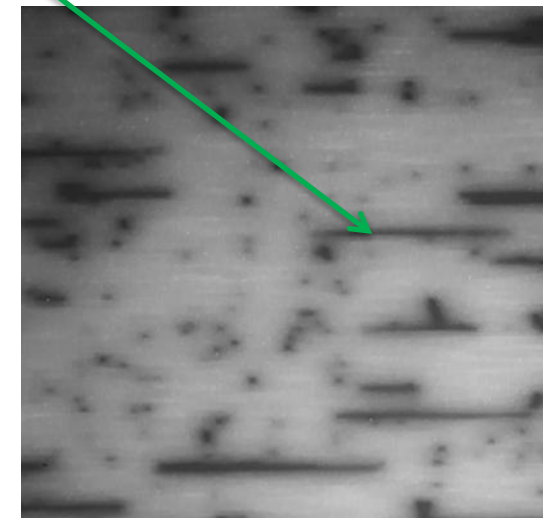
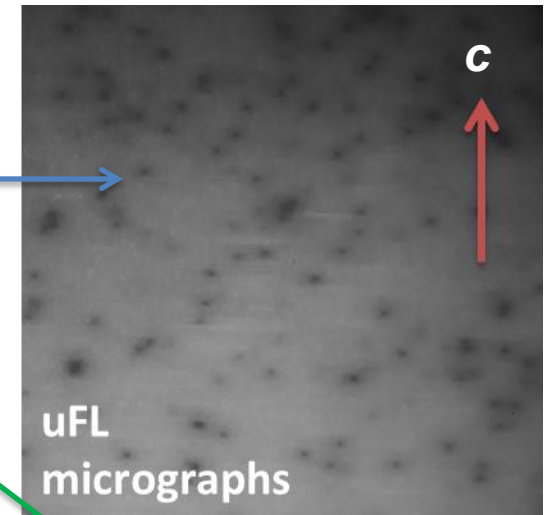
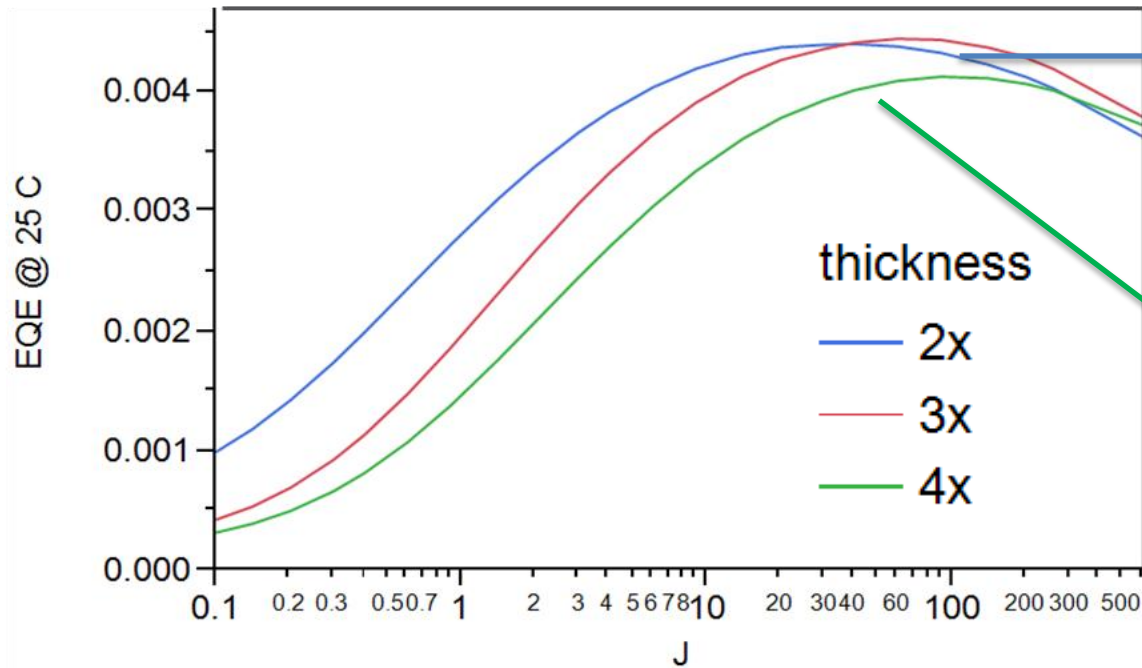
**IQE @ 150 A/cm<sup>2</sup> and 100 °C: 70%**

**Year 1 results exceed State-of-Art performance level by ~10%**



# Key Lessons Learnt

## Impact of Active Region Volume



- Thicker active regions allow carrier spreading
- Thicker active regions also show some sign of reduced crystal quality

# Project Integration and Collaboration

## Project Integration:

Relevant results from the program are disseminated to a broader audience at the annual DOE Solid State Lighting R&D Workshops.

## Communications:

Results from this program have been presented in the following workshops:

- DOE Solid State Lighting R&D Workshop, Jan 29 – 31, 2013, Long Beach, CA (both Oral and Poster presentation)
- DOE Solid State Lighting R&D Workshop, Jan 28 – 30, 2014, Tampa, FL (Poster presentation only)

# Next Steps and Future Plans

## Year 2 Goals:

- Optimize IQE (at 150 A/cm<sup>2</sup>, 100 °C) as a function of wavelength (400-450 nm)
- Identify primary physical mechanism behind IQE degradation at high current densities and high temperature as function of wavelength
- Demonstrate IQE >80% at 150A/cm<sup>2</sup> and 100 °C in the wavelength range 400-450nm
- Fabricate LED lamps using optimized semipolar LED structures

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# REFERENCE SLIDES

# Project Budget

**Project Budget:**

			Total (DOE + Soraa)	DOE	Soraa
<i>Cost Share: 30%</i>					
PROJECT BUDGET	<i>PHASE 1 + 2 (9/1/11 - 8/31/14)</i>	TOTAL	\$968,355.00	\$679,863.75	\$288,491.25
PHASE 1 BUDGET	<i>PHASE 1 (9/1/11 - 8/31/12)</i>	TOTAL	\$483,115.00	\$339,188.13	\$143,926.88
PHASE 1 SPENDING	<i>PHASE 1 (9/1/11 - 8/31/12)</i>	TOTAL	\$535,732.32	\$377,865.31	\$157,867.01
PHASE 2 BUDGET	<i>PHASE 2 (9/1/12 - 8/31/13)</i>	TOTAL	\$485,240.00	\$340,675.63	\$144,564.38
PHASE 2 SPENDING	<i>PHASE 2 (9/1/12 - 2/28/14)</i>	TOTAL	\$105,377.52	\$84,302.02	\$21,075.50
REMAINING	<i>YEAR 2 (10/1/13 - 8/31/14)</i>	TOTAL	\$327,245.16	\$217,696.42	\$109,548.74

**Variances: None**

**Cost to Date: 66%**

**Additional Funding: None**

<b>Budget History</b>			
<b>9/1/2011 – FY2013 (past)</b>		<b>FY2014 (End date: Aug 31, 2014)</b>	
<b>DOE</b>	<b>Cost-share</b>	<b>DOE</b>	<b>Cost-share</b>
\$462,167.33	\$178,942.51	\$217,696.42	\$109,548.74

# Project Plan and Schedule

Project Schedule												
Project Start: 9/1/2011	Completed Work											
Projected End: 8/31/2014	Active Task (in progress work)											
	◆ Milestone/Deliverable (Originally Planned)											
	◆ Milestone/Deliverable (Actual)											
	FY 2011-2012				FY 2012-2013				FY 2013-2014			
Tasks	Q1 (Sep - Nov)	Q2 (Dec - Feb)	Q3 (Mar - May)	Q4 (Jun - Aug)	Q1 (Sep - Nov)	Q2 (Dec - Feb)	Q3 (Mar - May)	Q4 (Jun - Aug)	Q1 (Sep - Nov)	Q2 (Dec - Feb)	Q3 (Mar - May)	Q4 (Jun - Aug)
<b>Past Work</b>												
Task 1: Program Management Plan	◆											
Task 2: Optimize 405nm Semipolar LEDs			◆									
Task 3: Establish EL based IQE metrology		◆										
Task 4: Understand IQE degradation mechanism			◆									
Task 5: Design and fabricate 405nm semipolar LED				◆								
Task 6: Demonstrate IQE>70% at 150A/cm2 and 100C				◆								
<b>Current/Future Work</b>												
Task 7: Optimize 400-450 nm Semipolar LEDs								◆				◆
Task 8: Understand IQE degradation mechanism								◆				◆
Task 9: Design and fabricate 400-450nm semipolar LED									◆			◆
Task 10: Fabricate Semipolar LED									◆			◆

Phase II work has been delayed due to relocation of work site and substrate quality issues